

| L Number | Hits | Search Text | DB | Time stamp |
|----------|--------|--|---|------------------|
| 1 | 70975 | heat\$4 near3 mold\$4 | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/09/30 15:59 |
| 2 | 112037 | heat\$4 near3 (mould\$4 or mold\$4 or emboss\$4 or imprint\$4) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/09/30 15:59 |
| 3 | 35248 | (heat\$4 near3 (mould\$4 or mold\$4 or emboss\$4 or imprint\$4)) same temperature | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/09/30 16:00 |
| 4 | 19966 | ((heat\$4 near3 (mould\$4 or mold\$4 or emboss\$4 or imprint\$4)) same temperature) same (low\$4 or high\$4 or decreas\$4 or increas\$4 or rais\$4 or great\$4 or less\$4) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/09/30 16:01 |
| 5 | 15 | ((((heat\$4 near3 (mould\$4 or mold\$4 or emboss\$4 or imprint\$4)) same temperature) same (low\$4 or high\$4 or decreas\$4 or increas\$4 or rais\$4 or great\$4 or less\$4)) same (thermal adj cycling) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/09/30 16:04 |
| 6 | 7309 | ((((heat\$4 near3 (mould\$4 or mold\$4 or emboss\$4 or imprint\$4)) same temperature) same (low\$4 or high\$4 or decreas\$4 or increas\$4 or rais\$4 or great\$4 or less\$4)) same (press\$4 or urg\$4 or impress\$4 or imprint) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/09/30 16:04 |
| 7 | 2784 | 6.ab. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/09/30 16:05 |
| 8 | 772 | temperature adj tool | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/09/30 16:05 |
| 9 | 22 | ((((heat\$4 near3 (mould\$4 or mold\$4 or emboss\$4 or imprint\$4)) same temperature) same (low\$4 or high\$4 or decreas\$4 or increas\$4 or rais\$4 or great\$4 or less\$4)) same (press\$4 or urg\$4 or impress\$4 or imprint)) and (temperature adj tool) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/09/30 16:05 |

| L Number | Hits | Search Text | DB | Time stamp |
|----------|------|---|---|------------------|
| 1 | 2234 | (eliminat\$4 or reduc\$4 or lower\$4) with (thermal adj cycl\$4) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/09/30 15:39 |
| 2 | 106 | ((eliminat\$4 or reduc\$4 or lower\$4) with (thermal adj cycl\$4)) same (imprint\$4 or emboss\$4 or stamp\$4 or mold\$4) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/09/30 15:21 |
| 3 | 70 | ((((eliminat\$4 or reduc\$4 or lower\$4) with (thermal adj cycl\$4)) same (imprint\$4 or emboss\$4 or stamp\$4 or mold\$4)) same (preheat\$4 or heat\$4 or temperature or c or f) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/09/30 15:26 |
| 4 | 4 | (imprint\$4) with (thermal adj cycl\$4) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/09/30 15:40 |
| 5 | 3 | chou.in. and alanko | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/09/30 15:41 |